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Power Inductor

AHP252010AF-SERIES

P1

	ECN HISTORY LIST									
REV	DATE	DESCRIPTION	APPROVED	CHECKED	DRAWN					
1.0	16/03/18	新發行	楊祥忠	詹偉特	孔妍暄					
備										
註										

Power Inductor

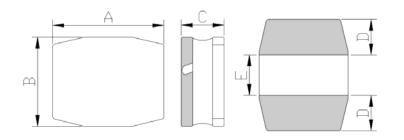
AHP252010AF-SERIES

1. Features

- 1. This specification applies Low Profile Power Inductors.
- 2. 100% Lead(Pb) & Halogen-Free and RoHS compliant.

2. Dimension

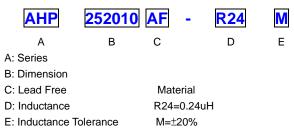




Series	A(mm)	B(mm)	C(mm)	D(mm)	E(mm)
AHP252010AF	2.5 -0.1/+0.2	2.0 -0.1/+0.2	1.0Max	0.75 ref.	1.00 ref.
Linita: mm					

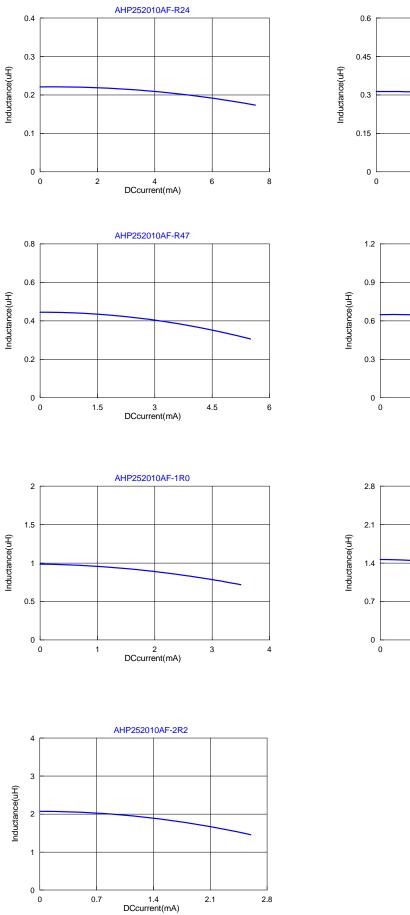
Units: mm

3. Part Numbering

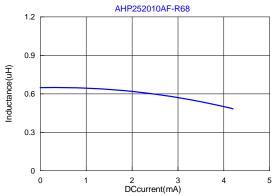


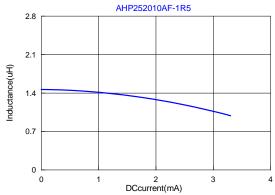
4. Specification

TAI-TECH Part Number	Inductance (uH)	Tolerance (%)	Test Frequency (Hz)	DCR (Ω) typ.	DCR (Ω) Max.	l sat (A) typ.	l sat (A) Max.	l rms (A) typ	l rms (A) MAX
AHP252010AF-R24M	0.24	±20	1V/1M	0.024	0.032	7.200	6.70	4.70	4.00
AHP252010AF-R33M	0.33	±20	1V/1M	0.025	0.033	5.50	5.15	4.50	3.85
AHP252010AF-R47M	0.47	±20	1V/1M	0.030	0.038	5.50	4.90	3.80	3.20
AHP252010AF-R68M	0.68	±20	1V/1M	0.042	0.052	4.20	3.60	3.40	3.00
AHP252010AF-1R0M	1.0	±20	1V/1M	0.050	0.062	3.50	3.00	3.10	2.60
AHP252010AF-1R5M	1.5	±20	1V/1M	0.080	0.096	3.20	2.70	2.40	2.10
AHP252010AF-2R2M	2.2	±20	1V/1M	0.110	0.132	2.50	2.10	2.10	1.80



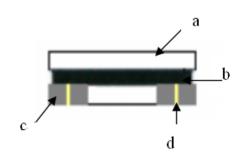
AHP252010AF-R33

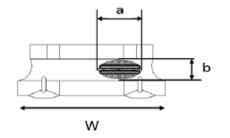




5. Material List

No.	No. Description Specification				
a.	Core	Metal Core			
b.	Glue	Epoxy with magnetic powder			
с	Termination	Tin (Pb Free)			
d	Wire	Enameled Copper Wire			





Appearance of exposed wire tolerance limit :

- 1. Width direction (dimension a): Acceptable when a \leq w/2 Nonconforming when a > w/2
- Length direction (dimension b): Dimension b is not specified.
 The total area of exposed wire occurring to each sides is
- not greater than 50% of coating resin area, and is acceptable.

6. Reliability and Test Condition

Item	Performance	Test Condition
Operating temperature	-40~+125°C (Including self - temperature rise)	
Storage temperature	-40~+125℃ (on board)	
Electrical Performance Te	st	I
		HP4284A,CH11025,CH3302,CH1320,CH1320S
Inductance	Refer to standard electrical characteristics list.	LCR Meter.
DCR		CH16502,Agilent33420A Micro-Ohm Meter.
	61 < 200/ trained	Saturation DC Current (Isat) will cause L0
Saturation Current (Isat)	∆L≦30% typical.	to drop _L(%)(keep quickly).
		Heat Rated Current (Irms) will cause the coil temperature rise
		$ riangle T(\C)$ without core loss.
Heat Rated Current (Irms)	Approximately $\triangle T \leq 40^{\circ}C$	1.Applied the allowed DC current(keep 1 min.).
		2.Temperature measured by digital surface thermometer
Reliability Test	·	
Life Test		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles) Temperature : 125±2°C (Inductor) Applied current : rated current Duration : 1000±12hrs Measured at room temperature after placing for 24±2 hrs
Load Humidity		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles Humidity : 85±2 * R.H, Temperature : 85°C±2°C Duration : 1000hrs Min. with 100% rated current Measured at room temperature after placing for 24±2 hrs
Moisture Resistance	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	 Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J-STD-020DClassification Reflow Profiles 1. Baked at50°C for 25hrs, measured at room temperature after placing for 4 hrs. 2. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 3. Raise temperature to 65±2°C 90-100%RH in 2.5hrs, and keep 3 hours, cool down to 25°C in 2.5hrs. 4. Keep at 25°C 80-100%RH for 15min and vibrate at the frequency of 10 to 55 Hz to 10 Hz, measure at room temperature after placing for 1–2 hrs.
Thermal shock		Preconditioning: Run through IR reflow for 2 times.(IPC/JEDEC J_STD-020DClassification Reflow Profiles Condition for 1 cycle Step1 : -40±2℃ 30±5min Step2 : 25±2℃ ≤0.5min Step3 : 125±2℃ 30±5min Number of cycles : 500 Measured at room temperature after placing for 24±2 hrs
Vibration		Oscillation Frequency: 10 ~ 2K ~ 10Hz for 20 minutes Equipment : Vibration checker Total Amplitude:1.52mm±10% Testing Time : 12 hours(20 minutes, 12 cycles each of 3 orientations) *

Item	Performance	Test Condition					
Shock	Appearance : No damage. Inductance : within±10% of initial value	Type SMD	Peak value (g's) 1500	Normal duration (I (ms) 0.5	D)	Wave form Half-sine	Velocity change (Vi)ft/sec 15.4
Bending	Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	followir <0805: Bendin <0805:	ng dimensio 40x100x0.	=0805:1.2mn	ubstra :40x1		12.3
Soderability	More than 95% of the terminal electrode should be covered with solder •	Solder: Tempe Flux fo Dip tim	rature: 245 r lead free: e: 4±1sec	Ag3% Cu0.5 5±5℃ : Rosin. 9.5%	, D°	ation	
Resistance to Soldering Heat	Appearance : No damage. Inductance : within±10% of initial value Q : Shall not exceed the specification value. RDC : within ±15% of initial value and shall not exceed the specification value	Temp (°C)	erature 5(solder	Time(s)	ramp, and e	perature /immersion emersion ra n/s ±6 mm/	ite
Terminal Strength		times.(Reflow With th tested, (>0805 tested. applied gradua	Profiles e compone apply a for :1kg , <=0 This force I for 60 +1 Ily as not to	C J-STD-020 ent mounted rce 0805:0.5kg)to shall be I seconds. A	0DČla on a o the Also t	ASSIFICATION PCB with t side of a the force s	
		11	DU		pre	ass tool	thick

7. Soldering and Mounting

7-1. Soldering

Mildly activated rosin fluxes are preferred. TAI-TECH terminations are suitable for all wave and re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

7-1.1 Solder re-flow:

Recommended temperature profiles for re-flow soldering in Figure 1.

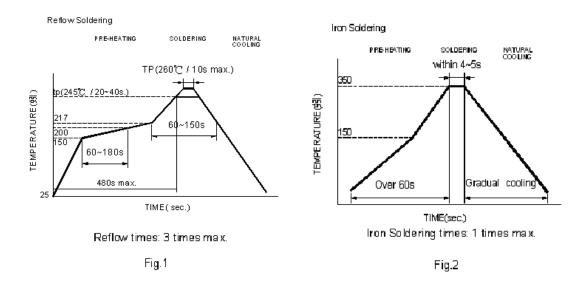
7-1.2 Soldering Iron(Figure 2):

Products attachment with a soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended.

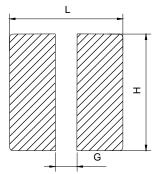
- Preheat circuit and products to 150 $^\circ\!{\rm C}$
 • 355℃ tip temperature (max)

Never contact the ceramic with the iron tip
1.0mm tip diameter (max)

Use a 20 watt soldering iron with tip diameter of 1.0mm
Limit soldering time to 4~5 sec.



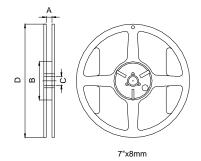
7-2. Recommended PC Board Pattern



L(mm)	G(mm)	H(mm)
2.9	1.0	2.4

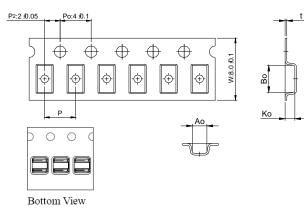
8. Packaging Information

8-1. Reel Dimension



Туре	A(mm)	B(mm)	C(mm)	D(mm)
7"x8mm	8.4±1.0	50 min.	13±0.8	178±2

8-2. Tape Dimension / 8mm

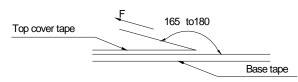


Series	Size	Bo(mm)	Ao(mm)	Ko(mm)	P(mm)	t(mm)
AHP	252010	2.85±0.1	2.45±0.1	1.40±0.1	4.0±0.1	0.23±0.05

8-3. Packaging Quantity

Chip size	252010
Chip / Reel	2000

8-4. Tearing Off Force



The force for tearing off cover tape is 15 to 80 grams in the arrow direction under the following conditions.

Room Temp.	oom Temp. Room Humidity		Tearing Speed
(°C)	(%)	(hPa)	mm/min
5~35	45~85	860~1060	300

Application Notice

- Storage Conditions(component level)
 - To maintain the solderability of terminal electrodes:
 - 1. TAI-TECH products meet IPC/JEDEC J-STD-020D standard-MSL, level 1.
 - 2. Temperature and humidity conditions: Less than 40 $^\circ\!\mathrm{C}$ $\,$ and 60% RH.
 - 3. Recommended products should be used within 12 months form the time of delivery.
 - 4. The packaging material should be kept where no chlorine or sulfur exists in the air.

Transportation

- 1. Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- 2. The use of tweezers or vacuum pick up is strongly recommended for individual components.
- 3. Bulk handling should ensure that abrasion and mechanical shock are minimized.

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